

Electronic Patent Application Fee Transmittal

| | | | | |
|---|---|-----------------|---------------|-----------------------------|
| Application Number: | 10763356 | | | |
| Filing Date: | 23-Jan-2004 | | | |
| Title of Invention: | Etching method for manufacturing semiconductor device | | | |
| First Named Inventor/Applicant Name: | Won-Jun Lee | | | |
| Filer: | Alexander Charles Johnson/Li mei Vermilya | | | |
| Attorney Docket Number: | 9898-314 | | | |
| Filed as Large Entity | | | | |
| Utility Filing Fees | | | | |
| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
| Basic Filing: | | | | |
| Pages: | | | | |
| Claims: | | | | |
| Independent claims in excess of 3 | 1201 | 1 | 200 | 200 |
| Miscellaneous-Filing: | | | | |
| Petition: | | | | |
| Patent-Appeals-and-Interference: | | | | |
| Post-Allowance-and-Post-Issuance: | | | | |
| Extension-of-Time: | | | | |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|-------------------|----------|----------|--------|----------------------|
| Miscellaneous: | | | | |
| Total in USD (\$) | | | | 200 |